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MOSFET, N-Channel, POWERTRENCH[®], **60 V, 30 A, 15 m**Ω

Features

- Typical $R_{DS(on)} = 12.5 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 30 \text{ A}$
- Typical $Q_{G(tot)} = 13 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 25 \text{ A}$
- UIS Capability
- RoHS Compliant

Applications

- DC–DC Power Supplies
- AC-DC Power Supplies
- Motor Control
- Load Switching

MOSFET MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

		- ··	
Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	60	V
V _{GS}	Gate-to-Source Voltage	±20	V
I _D	Drain Current – Continuous (VGS = 10) T _C = 25°C (Note 1)	30	A
	Pulsed Drain Current, $T_C = 25^{\circ}C$	See Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 2)	13.5	mJ
PD	Power Dissipation	50	W
	Derate Above 25°C	0.33	W/°C
T _J , T _{STG}	Operating and Storage Temperature	–55 to +175	°C
$R_{\theta JC}$	$R_{\theta JC}$ Thermal Resistance, Junction to Case		°C/W
$R_{ hetaJA}$	R _{0JA} Maximum Thermal Resistance, Junction to Ambient (Note 3)		°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

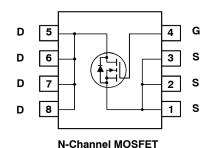
- 1. Current is limited by bondwire configuration.
- 2. Starting T_J = 25°C, \dot{L} = 40 μ H, I_{AS} = 26 A, V_{DD} = 60 V during inductor charging and V_{DD} = 0 V during time in avalanche.
 R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal
- resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2 oz copper.



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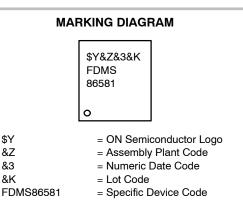
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ELECTRICAL CONNECTION





Power 56 (PQFN8 5x6) CASE 483AE



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

PACKAGE MARKING AND ORDERING INFORMATION

Gate-to-Source Leakage Current

Device Marking	Device	Package	Shipping [†]
FDMS86581	FDMS86581	Power 56	3000 Units/ Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Тур.	Max.	Units
OFF CHAR	ACTERISTICS						
B _{VDSS}	Drain-to-Source Breakdown Voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS} =$	0 V	60	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	$V_{DS} = 60 V,$	$T_J = 25^{\circ}C$	-	_	1	А
		V _{GS} = 0 V	T 17500 (Nists 4)			4	A

T_J = 175°C (Note 4)

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1

±100

_

_

mΑ

nA

ON CHARACTERISTICS

I_{GSS}

V _{GS(th)}	Gate to Source Threshold Voltage	V_{GS} = V_{DS} , I_D = 250 μ A		2.0	2.7	4.0	V
R _{DS(on)}	Drain to Source On Resistance	$I_{\rm D} = 30 \rm A,$	$T_J = 25^{\circ}C$	-	12.5	15.0	mΩ
		V _{GS} = 10 V	$T_J = 175^{\circ}C$ (Note 4)	-	25.1	30.1	mΩ

 $V_{GS} = \pm 20 V$

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 30 V, V_{GS} = 0 V, f = 1 MHz	-	881	-	pF
C _{oss}	Output Capacitance]	_	281	-	pF
C _{rss}	Reverse Transfer Capacitance]	_	15	-	pF
R _G	Gate Resistance	f = 1 MHz	-	3.1	-	Ω
Q _{g(ToT)}	Total Gate Charge	V_{GS} = 0 to 10 V, V_{DD} = 30 V, I_{D} = 25 A	-	13	19	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V, V_{DD} = 30 V, I_{D} = 25 A	-	2	-	nC
Q _{gs}	Gate-to-Source Gate Charge	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 25 \text{ A}$	-	4	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge		_	3	_	nC

SWITCHING CHARACTERISTICS

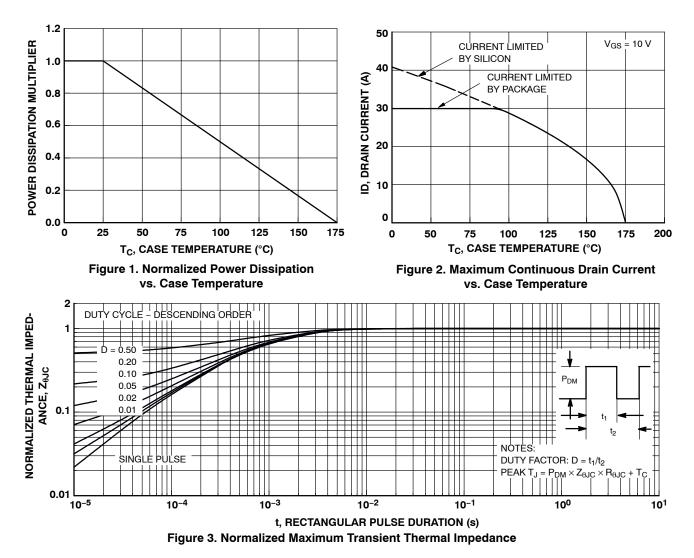
t _{on}	Turn–On Time	V_{DD} = 30 V, I_{D} = 30 A, V_{GS} = 10 V, R_{GEN} = 6 Ω	-	-	20	ns
t _{d(on)}	Turn-On Delay	HGEN - 0 52	-	9	-	ns
tr	Rise Time		-	5	-	ns
t _{d(off)}	Turn-Off Delay		_	15	_	ns
t _f	Fall Time		-	4	-	ns
t _{off}	Turn-Off Time		-	-	28	ns

DRAIN-SOURCE DIODE CHARACTERISTICS

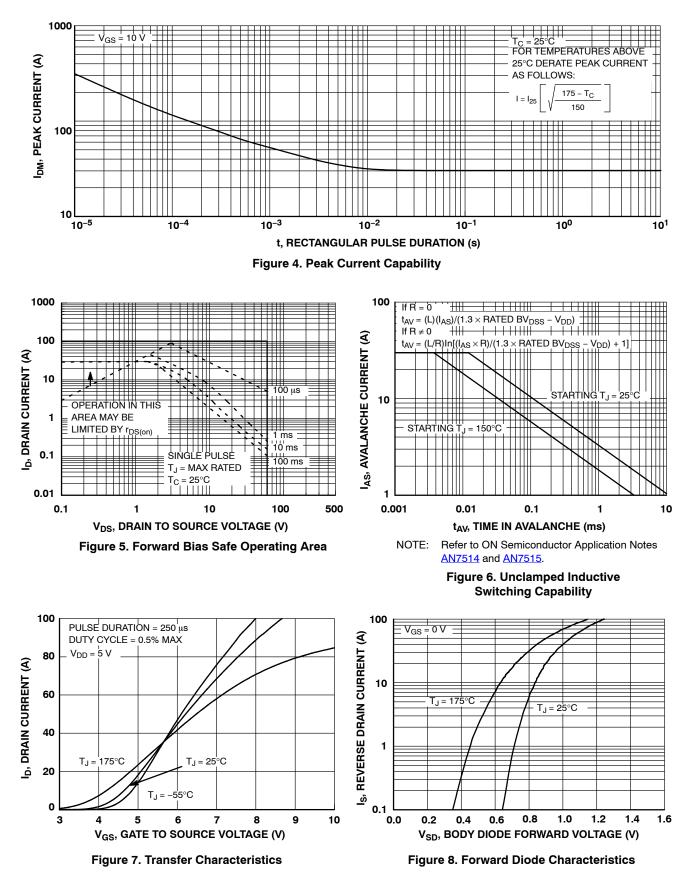
V _{SD}	Source-to-Drain Diode Voltage	$I_{SD} = 30 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1.25	V
		$I_{SD} = 15 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	I_F = 30 A, dI_{SD}/dt = 100 A/µs, V_{DD} = 48 V	-	37	55	ns
Q _{rr}	Reverse Recovery Charge		-	22	33	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production.

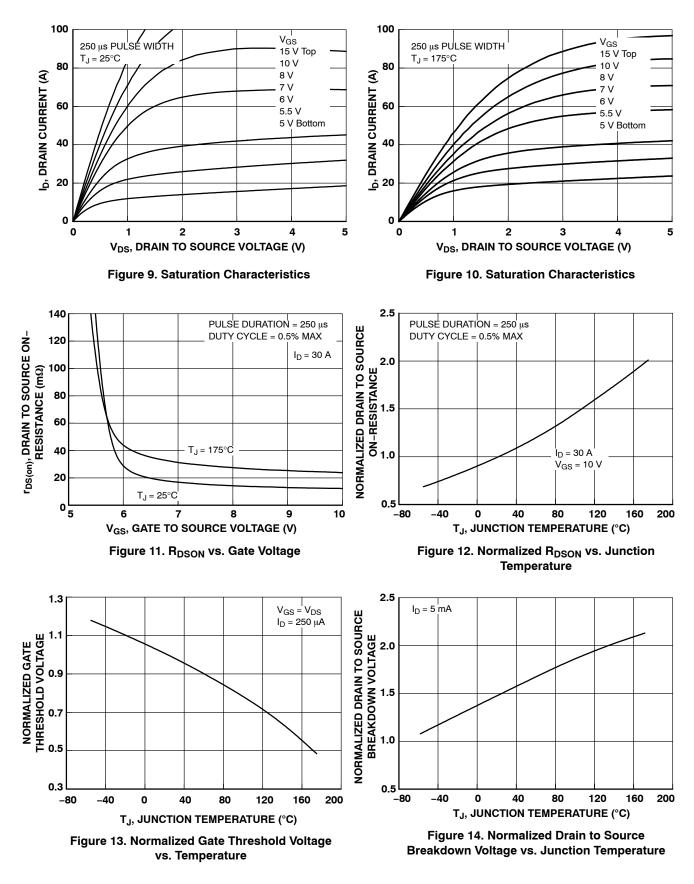
TYPICAL CHARACTERISTICS



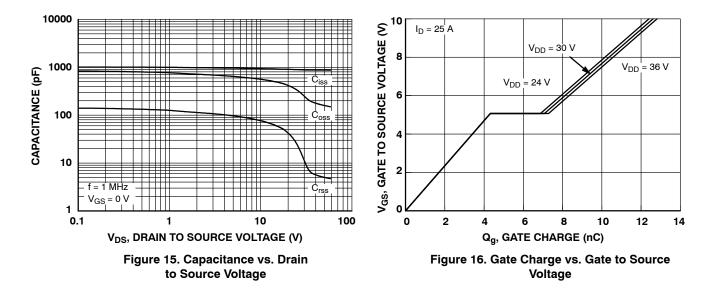
TYPICAL CHARACTERISTICS (continued)



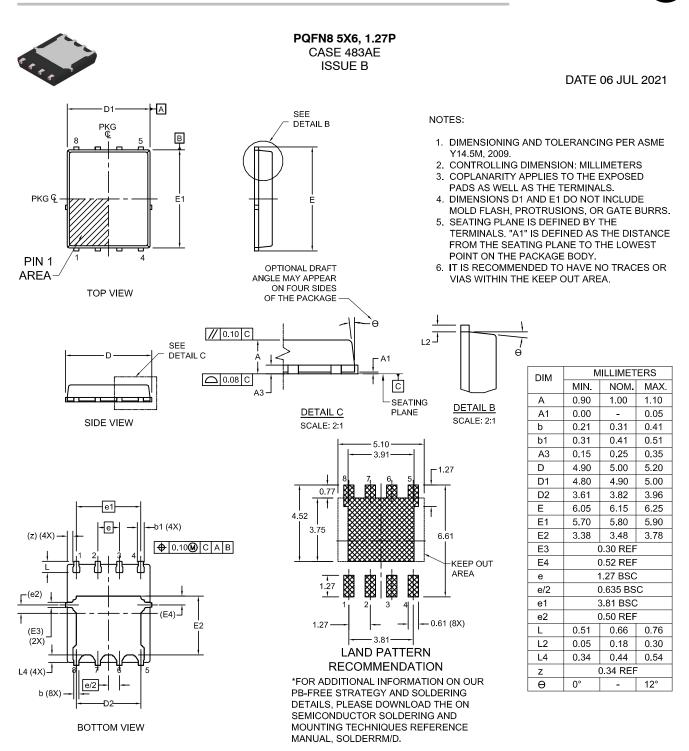
TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)



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